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Effects of Ammonia Flow Rate on the Synthesis of AlGa_{0.8}N Thin Films prepared via Spin Coating Approach

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Keywords: aluminum gallium nitride; sol-gel; spin coating; flow rate; wurtzite

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ABSTRACT

We report on the growth of the aluminum gallium nitride (AlGa_{0.8}N) thin films on aluminum nitride (AlN) on silicon (111) template via sol-gel spin coating method followed by nitridation process. The nitridation process was carried out for 75 min under ammonia (NH₃) ambient. To investigate the effects of NH₃ flow rate on synthesis film, different NH₃ flow rates (i.e., 200 sccm, 300 sccm and 400 sccm) were used. The structural properties and surface morphologies of the deposited films were accessed using X-ray diffraction (XRD), field-emission scanning electron microscopy (FESEM) and atomic force microscopy (AFM). The XRD results reveal that all the deposited AlGa_{0.8}N thin films have wurtzite structure with the preferred growth orientation along the (002) crystallographic direction. As the NH₃ flow rate increases, the intensity of (002) peaks and crystalline quality were improved. The FESEM and AFM results show that the deposited AlGa_{0.8}N thin film have uniform and smooth surface. The optical properties of AlGa_{0.8}N thin films were investigated by using Fourier transform infrared (FTIR) spectroscopy under the reflectance mode. The infrared reflectance results show that the intensity of E₁(TO) peaks of the AlGa_{0.8}N increases with increasing NH₃ flow rate. All the results reveal that the NH₃ flow rate has significant effects on the structural, surface morphologies and optical properties of the deposited films. Finally, these results lead to conclude that the optimum NH₃ flow rate is 400 sccm.

1 Introduction

Aluminum gallium nitride (AlGa_{0.8}N) semiconductors have been widely applied in the fabrication of optoelectronics devices operating in blue and violet regions of the spectrum and semiconductors light emitting device [1–4]. This is owing to their direct and tune able band gap energy (ranging from 3.4 to 6.2 eV). Moreover, AlGa_{0.8}N semiconductor has superior physical properties such as excellent thermal conductivity [5], mechanical and chemical stability.

Synthesizing of AlGa_{0.8}N thin films by chemical solution deposition method using nitrogen gas (N₂) as a nitrogen (N) source has been reported by Sutanto et al. [6]. According to Sutanto et al. [6], N₂ was used due to its high reactivity through heating at high temperature. However, their EDX analysis results showed a low N concentration. It has been reported by Fong et al. [6–8] and Sardar et al. [10] that, the gallium nitride (GaN) thin films are successfully deposited using NH₃ via sol-gel spin coating method. However, the use of NH₃ for synthesizing of AlGa_{0.8}N thin films prepared by spin coating method has not yet been explored. Generally, the NH₃ gas is used as a source of N in epitaxy of nitride-based materials [11]. Also the flow rates of the NH₃ is one of the growth parameters that play an important role in the synthesis of nitride-based materials.

In the present work, the Al_{0.2}Ga_{0.8}N thin films were prepared using a simple and cost effective spin coating method. The attention of this work is to investigate the effects of NH₃ flow rate on the structural, surface morphologies and